



## Recent Advances in the Internet of Things (IoT): Architecture, Protocols and Security

Guest Editor:

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Deadline for manuscript  
submissions:

**closed (20 July 2023)**

### Message from the Guest Editor

Dear Colleagues,

As an emerging technology, the Internet of things (IoT) has become popular. The Internet of things (IoT) is aimed at enabling the interconnection and integration of the physical world and cyber space. It represents the trend of future networking and leads the third wave of the IT industry revolution.

This Special Issue aims at publishing a collection of research contributions illustrating the recent achievements in all aspects of the development, studying, and understanding of the Internet of things. We hope to establish a collection of papers that will be of interest to scholars in the field. Contributions in the form of full papers, reviews, and communications about related topics are very welcome.

Prof. Dr. Guangquan Xu

*Guest Editor*





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## Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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